

FRX-M7663BU6

**802.11ac 2T2R 867Mbps WLAN + Bluetooth v5.1
Combo USB2.0 Module Specification**



Module Name: FRX-M7663BU6	
Module Type: 802.11a/b/g/n/ac 867Mbps WLAN + Bluetooth v5.1 Combo USB2.0 Module	
Revision: V0.1	
Customer Approval:	
Company:	
Title:	
Signature:	Date:
B-link Approval:	
Title:	
Signature:	Date:

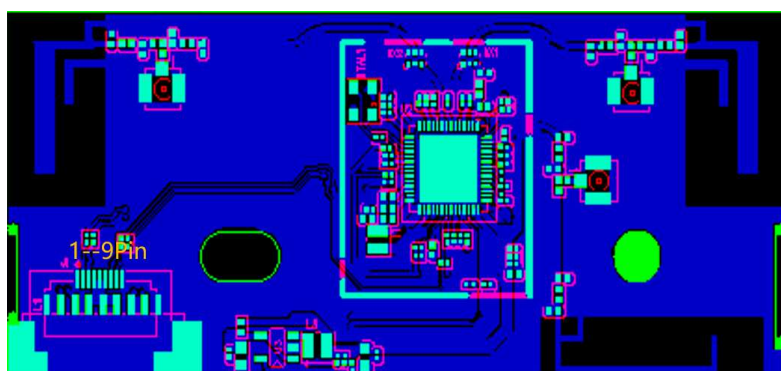
Revision History

Revision	Summary	Release Date	Revised By
V1.0	Internal release	2025-01-22	Ch

1.3 General Specifications

Module Name	FRX-M7663BU6
Chipset	MT7663BUN
WLAN Standards	IEEE802.11a/b/g/n/ac
Host Interface	USB2.0 for WLAN & BT
Antenna	On board PCB printed antennas
Dimension	70.0mm x 30.0mm x 5.4 mm (L*W*H)
Power Supply	DC 5V±0.3V 1500mA (Max)
Operation Temperature	-20°C to +70°C
Operation Humidity	10% to 95% RH (Non-Condensing)

2. Pin Assignments



2.1 Pin Definition

No.	Pin Name	Type	I/O Level	Module Pin Description
1	GND	P	/	Ground for Power and I/O
2	D+	I/O	/	USB Communication signal USB-DP
3	D-	I/O	/	USB Communication signal USB-DM
4	VCC	I	5V	VCC5.0V
5	VCC	I	5V	VCC5.0V
6	VCC	I	5V	VCC5.0V
7	WL_HOST_WAKE	O	/	WL WAKEUP
8	RESET	I	/	Reset Controlled by main SOC
9	GND	P	/	Ground for Power and I/O

P: Power, I: Input, O: Output, I/O: In/Output, RF: Analog RF Port, A I/O: Analog In/Output

3. Electrical and Thermal Specifications

3.1 Recommended Operating Conditions

Parameters		Min	Typ	Max	Units
Ambient Operating Temperature		-20	25	70	°C
Supply Voltage	VDD5V	4.7	5	5.3	V

3.2 Digital I/O DC Specifications

Symbol	Parameter	Min	Typ	Max	Units
VIH	Input High Voltage	2.0	3.3	3.6	V
VIL	Input Low Voltage	--	0	0.9	V
VOH	Output High Voltage	2.97	--	3.3	V
VOL	Output Low Voltage	0	--	0.33	V

3.3 Antenna Specifications

Items	Frequency Range	Gain(max)	VSWR	polarization
WLAN ANT0 & WLAN ANT1	2.4~2.4835GHz(2.4GHz ISM Band)	3.0dBi	<3	Linear polarization
	5.15~5.835GHz(5GHz ISM Band)	3.0dBi	<3	Linear polarization
BT ANT	2.4~2.4835GHz(2.4GHz ISM Band)	3.0dBi	<3	Linear polarization

3.4 Current Consumption

Conditions : VDD5V=5V ; Ta:25°C ;			
Use Case	VDD5V Current(average)		
	Typ	Max	Units
WLAN & BT Unassociated (Linux Driver)	62	120	mA
2.4G WLAN TCP throughput T/RX 99Mbps (Linux Drive, BT disable)	366	780	mA
5G WLAN TCP throughput T/RX 315Mbps & BT LE 1Mbps MP3	448	1200	mA
BT LE 1Mbps MP3 playback (Linux Driver, WLAN disable)	102	140	mA
2.4G 11b@1Mbps TX 19dBm (1TX RF-Test)	252	350	mA
2.4G 11b@11Mbps TX 19dBm (1TX RF-Test)	253	340	mA
2.4G 11g@54Mbps TX 16dBm (1TX RF-Test)	184	280	mA
2.4G 11n@HT20_MCS0 TX 17dBm (1TX RF-Test)	224	320	mA
2.4G 11n@HT20_MCS7 TX 15.5dBm (1TX RF-Test)	183	280	mA
2.4G 11n@HT40_MCS8 2TX 16dBm (2TX RF-Test)	452	700	mA
2.4G 11n@HT40_MCS15 (2RX RF-Test)	83	140	mA
5G 11a @6Mbps TX 18.5dBm (1TX RF test)	270	360	mA
5G 11a @54Mbps TX 16dBm (1TX RF test)	245	360	mA
5G 11a @54Mbps RX (1RX RF test)	85	140	mA
5G 11n@HT40_MCS8 TX 16dBm (2TX RF test)	474	800	mA
5G 11n@HT40_MCS8 RX (2RX RF test)	86	140	mA
5G 11ac@VHT80 MCS9 TX 14dBm (2TX RF test)	429	800	mA

5G 11ac@VHT80_MCS9 RX (2RX RF test)	105	180	mA
BT BR_1M TX@7dBm (BT RF test, WLAN disable)	120	135	mA
BT BR_1M RX Active (BT RF test, WLAN disable)	70	90	mA
BT EDR_3M TX@7dBm (BT RF test, WLAN disable)	115	127	mA
BT EDR_3M RX Active (BT RF test, WLAN disable)	72	103	mA
BT LE_1M TX@7dBm (BT RF test, WLAN disable)	110	120	mA

4. WLAN & Bluetooth RF Specifications

4.1 2.4G WLAN RF Specification

Conditions : VDD5V=5V ; Ta:25°C	
Features	Description
WLAN Standard	IEEE 802.11b/g/n/ac CSMA/CA
Frequency Range	2.4~2.4835GHz (2.4GHz ISM Band)
Channels	Ch1~Ch13 (For 20MHz Channels)
Modulation	802.11b (DSSS): CCK, DQPSK, DBPSK; 802.11g (OFDM): BPSK, QPSK, QAM16, QAM64; 802.11n (OFDM): BPSK, QPSK, QAM16, QAM64;
Data Rate	802.11b: 1, 2, 5.5, 11Mbps; 802.11g: 6, 9, 12, 18, 24, 36, 48, 54Mbps; 802.11n (HT20): MCS0~MCS7(1T1R_SISO) 6.5~72.2Mbps; 802.11n (HT20): MCS8~MCS15(2T2R_MIMO) 13~144.4Mbps; 802.11n (HT40): MCS0~MCS7(1T1R) 13.5~150Mbps; 802.11n (HT40): MCS8~MCS15(2T2R) 27~300Mbps;
Frequency Tolerance	$\leq \pm 20\text{ppm}$

2.4G Receiver Specifications(WLAN_Ant0&WLAN_Ant1)			
RX Rate	Min Input Level(Typ, dBm)	Max Input Level(Typ, dBm)	PER
802.11b@1Mbps	-91	-5	< 8%
802.11b@11Mbps	-85	-5	< 8%
802.11g@6Mbps	-90	-5	< 10%
802.11g@54Mbps	-73	-5	< 10%
802.11n@HT20_MCS0	-86	-5	< 10%
802.11n@HT20_MCS7	-70	-5	< 10%
802.11n@HT40_MCS0	-86	-5	< 10%
802.11n@HT40_MCS7	-68	-5	< 10%
802.11ac@VHT40_MCS9	-63	-5	< 10%

4.2 5G WLAN RF Specification

Conditions: VDD5V=5V; Ta:25°C	
Features	Description
WLAN Standard	IEEE 802.11a/n/ac, CSMA/CA
Frequency Range	5.15~5.25GHz; 5.735~5.835GHz (5GHz ISM Band)
Channels	Ch36, Ch40, Ch44, Ch48; Ch149~Ch165 (For 20MHz Channels)
Modulation	802.11a (OFDM): BPSK, QPSK, QAM16, QAM64; 802.11n (OFDM): BPSK, QPSK, QAM16, QAM64;
Data Rate	802.11a: 6, 9, 12, 18, 24, 36, 48, 54Mbps; 802.11n (HT20): MCS0~MCS7(1T1R_SISO) 6.5~72.2Mbps; 802.11n (HT20): MCS8~MCS15(2T2R_MIMO) 13~144.4Mbps; 802.11n (HT40): MCS0~MCS7(1T1R) 13.5~150Mbps; 802.11n (HT40): MCS8~MCS15(2T2R) 27~300Mbps; 802.11ac (VHT20): MCS0~MCS8(1T1R) 6.5~86.7Mbps; 802.11ac (VHT20): MCS0~MCS8(2T2R) 13~173.3Mbps; 802.11ac (VHT40): MCS0~MCS9(1T1R)13.5~200Mbps;

	802.11ac (VHT40): MCS0~MCS9(2T2R)27~400Mbps; 802.11ac (VHT80): MCS0~MCS9(1T1R)29.3~433.3Mbps; 802.11ac (VHT80): MCS0~MCS9(2T2R)58.5~866.7Mbps;
Frequency Tolerance	$\leq \pm 20\text{ppm}$

5G Receiver Specifications(WLAN_Ant0&WLAN_Ant1)			
RX Rate	Min Input Level(Typ, dBm)	Max Input Level(Typ, dBm)	PER
802.11a@6Mbps	-91	-5	< 10%
802.11a@54Mbps	-72	-5	< 10%
802.11n@HT20_MCS0	-90	-5	< 10%
802.11n@HT20_MCS7	-71	-5	< 10%
802.11n@HT40_MCS0	-87	-5	< 10%
802.11n@HT40_MCS7	-68	-5	< 10%
802.11ac@VHT80_MCS0	-86	-5	< 10%
802.11ac@VHT80_MCS9	-61	-5	< 10%

4.3 Bluetooth RF Specification

Conditions: VDD5V=5V; Ta:25°C	
Features	Description

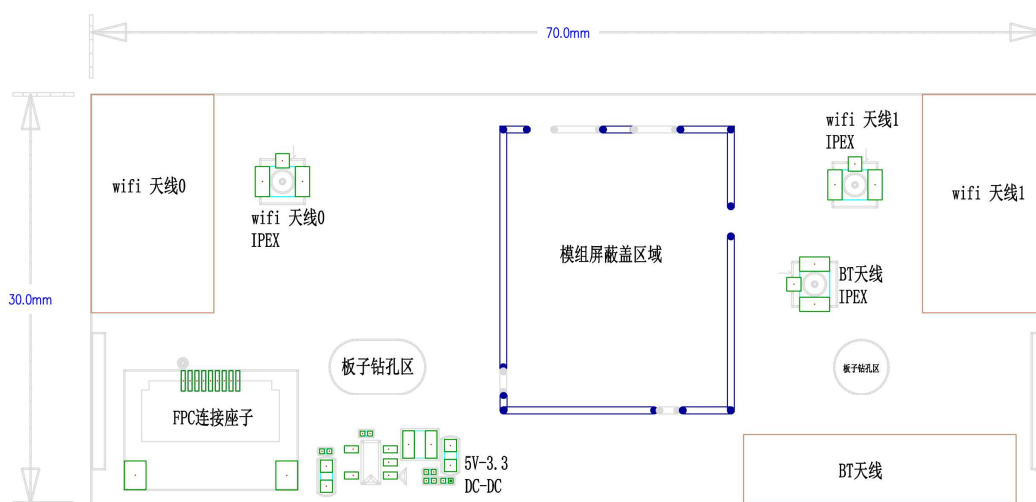
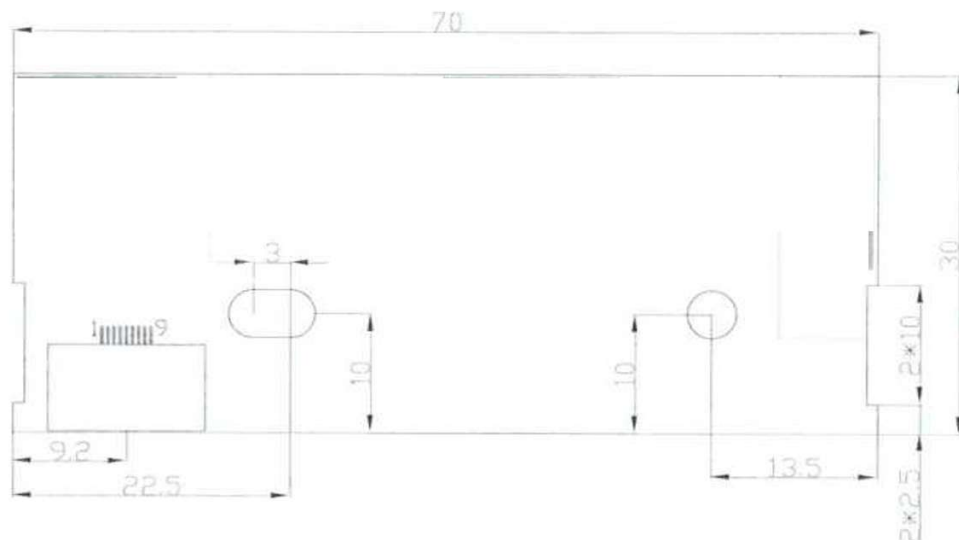
Bluetooth Specification	Bluetooth Core Specification v5.1		
Frequency Range	2.4~2.4835GHz (2.4GHz ISM Band)		
Channels	Bluetooth Classic: Ch0~Ch78 (For 1MHz Channels); Bluetooth Low Energy: Ch0~Ch39 (For 2MHz Channels);		
Power Classes	Bluetooth Classic BR/EDR: Class1; Bluetooth Classic Low Energy: Class1.5;		
Data Rate & Modulation	BR_1Mbps: GFSK; EDR_2Mbps: $\pi/4$ -DQPSK; EDR_3Mbps: 8DPSK; LE_1Mbps: GFSK (Uncoded);		
Bluetooth Transmitter Specifications (BT_Ant)			
Items	Min (dBm)	Typ (dBm)	Max (dBm)
TX Power			
BR_1M	5	8	11
EDR_2/3M	5	8	11
LE_/1M	2	5	8
Items	Min	Typ	Max
BR_1M (DH1) Modulation Characteristics			
Δf_{1avg}	140KHz	157.4KHz	175KHz
Δf_{2avg}	115KHz	161.5KHz	/
Δf_{2max}	115KHz	168.8KHz	/
$\Delta f_{2avg}/\Delta f_{1avg}$	0.8	1.02	/
Items	Min	Typ	Max
EDR_3M(3DH5) EDR Carrier Frequency Stability and Modulation Accuracy			
ω_i	-75KHz	7.53KHz	+75KHz
$\omega_i+\omega_o$	-75KHz	7.56KHz	+75KHz
ω_o	-10KHz	-0.39KHz	+10KHz
8DPSK RMS DEVm	/	0.042	0.13

8DPSK Peak DEVM	/	0.091	0.25
Items	Min	Typ	Max
LE_1M Modulation Characteristics			
Δf_{1avg}	225KHz	249KHz	275KHz
Δf_{2avg}	185KHz	240.2KHz	/
Δf_{2max}	185KHz	247.5KHz	/
$\Delta f_{2avg}/\Delta f_{1avg}$	0.8	0.96	/
Items	Min	Typ	Max

Bluetooth Receiver Specifications (BT_Ant)				
Items	Sensitivity		Maximum Input Level	
	Input Level(dBm)	BER	Input Level(dBm)	BER
BR_1M (DH1)	-90	$\leq 0.1\%$	-5	$\leq 0.1\%$
EDR_3M (3DH5)	-83	$\leq 0.01\%$	-5	$\leq 0.1\%$
	Input Level(dBm)	PER	Input Level(dBm)	BER
LE_1M	-91	$\leq 5\%$	-5	$\leq 5\%$

5. Mechanical Specifications

5.1 Module Outline Drawing



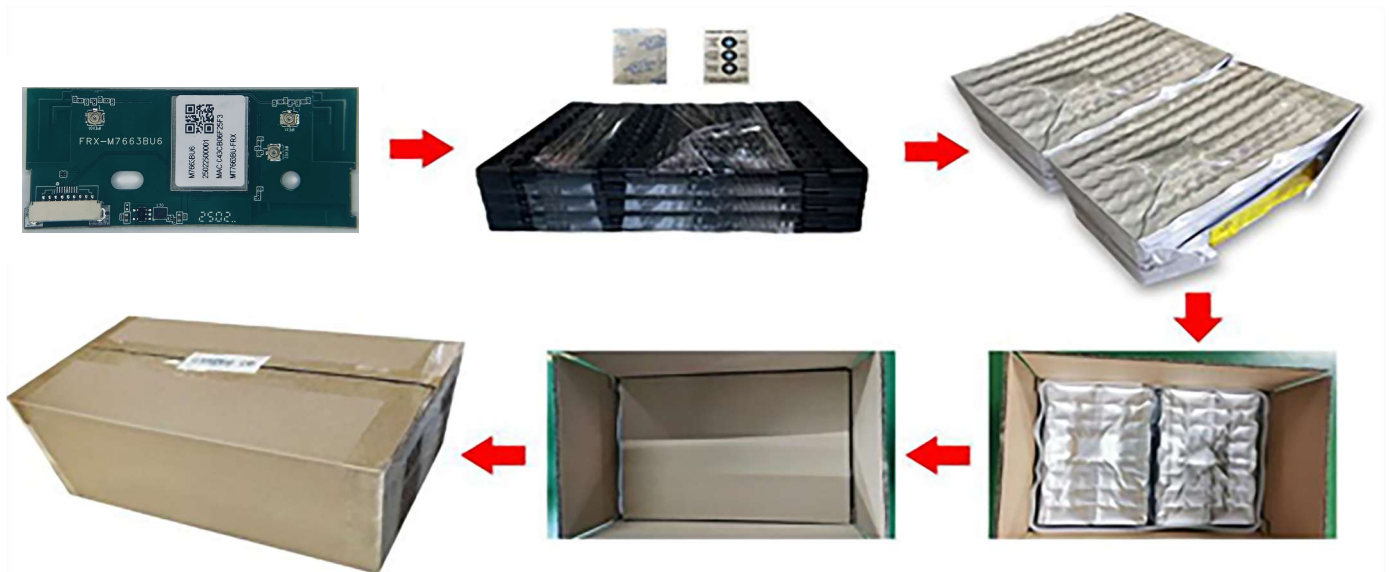
Module dimension: 70*30*5.4mm (L*W*H; Tolerance: $\pm 0.3\text{mm}_L/W$, $\pm 0.5\text{mm}_H$)

6. Key Components Of Module

No.	Parts	Specification	Manufacturer	Note
1	Chipset	MT7663BUN	MediaTek Inc.	
2	PCB	FRX-M7663BU6	ShenZhen Tie Fa Technology Limited	
			Huizhou Dayawan Kexiang Technology Circuit Board	
			SHEN ZHEN QILI ELECTRON CO.,LTD	
3	Crystal	40MHz-10PPM-12PF-3225	LUCKI CM ELECTRONICS CO.,LTD	
			Chengde oscillator Electronic Technology CO.,LTD	
			JinHua East Crystal Electronic CO.,LTD	
4	Diplexer	DP1608	Advanced Ceramic X Corp.	
			Dongguan Hekang Electronics Co.,LTD	
			JIA XING GLEAD ELECTRONICS CO.,LTD	

7. Package and Storage Information

7.1 Package Dimensions



Package specification:

1. 16 modules per blister plate and 448 modules per box.
2. The blister is bound with wire membrane and put into anti-static vacuum bag.
3. Put 1 bag of dry beads (20g) and 1 humidity card in each anti-static vacuum bag.
4. The outer box size is 43*35.5*16cm.

7.2 Storage Conditions

Absolute Maximum Ratings:

Storage temperature: -40°C to +85°C,

Storage humidity: 10% to 95 (Non-Condensing)

Recommended Storage Conditions:

Storage temperature: 5°C to +40°C,

Storage humidity: 20% to 90% RH

Please use this Module within 12month after vacuum-packaged.

ESD Sensitivity:

ESD Protection: 2KV(HBM ,Maximum rating)

The Module is a static-sensitive electronic device.

Do not operate or store near strong electrostatic fields.

Take proper ESD precautions!



ESD CAUTION

FCC Statement

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) this device must accept any interference received, including interference that may cause undesired operation.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

This modular has been tested and found to comply with part 15 requirements for Modular Approval.

FCC Caution: Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

Integration instructions for host product manufacturers according to KDB 996369 D03 OEM Manual v01r01

2.2 List of applicable FCC rules

CFR 47 FCC Part 15 Subpart C and Subpart F has been investigated. It is applicable to the modular transmitter

2.3 Specific Operational Use Conditions - Antenna Placement Within the Host Platform

The module is tested for standalone mobile RF exposure use condition.

- The antenna must be installed such that 20cm is maintained between the antenna and users,
 - The transmitter module may not be co-located with any other transmitter or antenna.
- In the event that these conditions cannot be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

2.4 Limited Module Procedures

Not applicable

2.5 Trace Antenna Designs

Not applicable

2.6 RF Exposure Considerations

This device complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

2.7 Antenna Type and Gain

The following antennas have been certified for use with this module.

Only antennas of the same type with equal or lower gain may also be used with this module.

Other types of antennas and/or higher gain antennas may require the additional authorization for operation.

Antenna Specification list below:

Model	Type	Connector	Peak gain (dBi)				
			2400-2483.5 MHz	5150-5250 MHz	5250-5350 MHz	5470-5725 MHz	5725-5850 MHz
/	External Antenna	SMA	3.00dBi	3.00dBi	/	/	3.00dBi
/	External Antenna	SMA	3.00dBi	3.00dBi	/	/	3.00dBi
/	External Antenna	SMA	3.00dBi	/	/	/	/

2.8 End Product Labelling Compliance Information

When the module is installed in the host device, the FCC ID label must be visible through a window on the final device or it must be visible when an access panel, door or cover is easily removed. If not, a second label must be placed on the outside of the final device that contains the following text: "Contains FCC ID: **2AVEDFRX-M7663BU6**". The FCC ID can be used only when all FCC compliance requirements are met.

2.9 Information on Test Modes and Additional Testing Requirements

This transmitter is tested in a standalone mobile RF exposure condition and any co-located or simultaneous transmission with other transmitter(s) class II permissive change re-evaluation or new FCC authorization.

Host manufacturer installed this modular with single modular approval should perform the test of radiated emission and spurious emission according to FCC part 15C, Part 15E, 15.209, 15.207 requirement, only if the test result comply with FCC part 15C, Part 15E, 15.209, 15.207 requirement, then the host can be sold legally.

2.10 Additional testing, Part 15 Subpart B Disclaimer

This transmitter modular is tested as a subsystem and its certification does not cover the FCC Part 15 Subpart B rules requirement applicable to the final host. The final host will still need to be reassessed for compliance to this portion of rules requirements if applicable.

As long as all conditions above are met, further transmitter test will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this modular installed.

2.11 Manual Information to The End User

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module.

The host integrator must follow the integration instructions provided in this document and ensure that the composite system end product complies with the requirements by a technical assessment or evaluation to the rules and to KDB Publication 996369.

The host integrator installing this module into their product must ensure that the final composite product complies with the requirements by a technical assessment or evaluation to the rules, including the transmitter operation and should refer to guidance in KDB Publication 996369.

OEM/Host Manufacturer Responsibilities

OEM/Host manufacturers are ultimately responsible for the compliance of the Host and Module. The final product must be reassessed against all the essential requirements of the FCC rule such as FCC Part 15 Subpart B before it can be placed on the US market.

This includes reassessing the transmitter module for compliance with the Radio and RF Exposure essential requirements of the FCC rules.

2.12 How to Make Changes - Important Note

In the event that these conditions cannot be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.